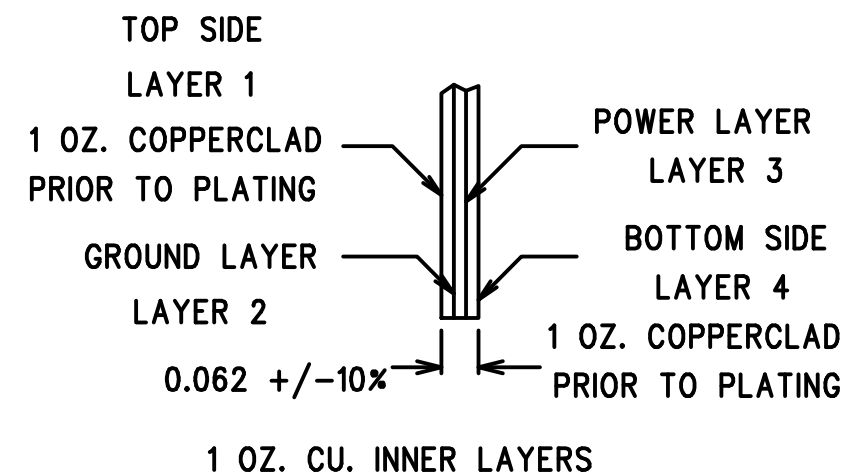
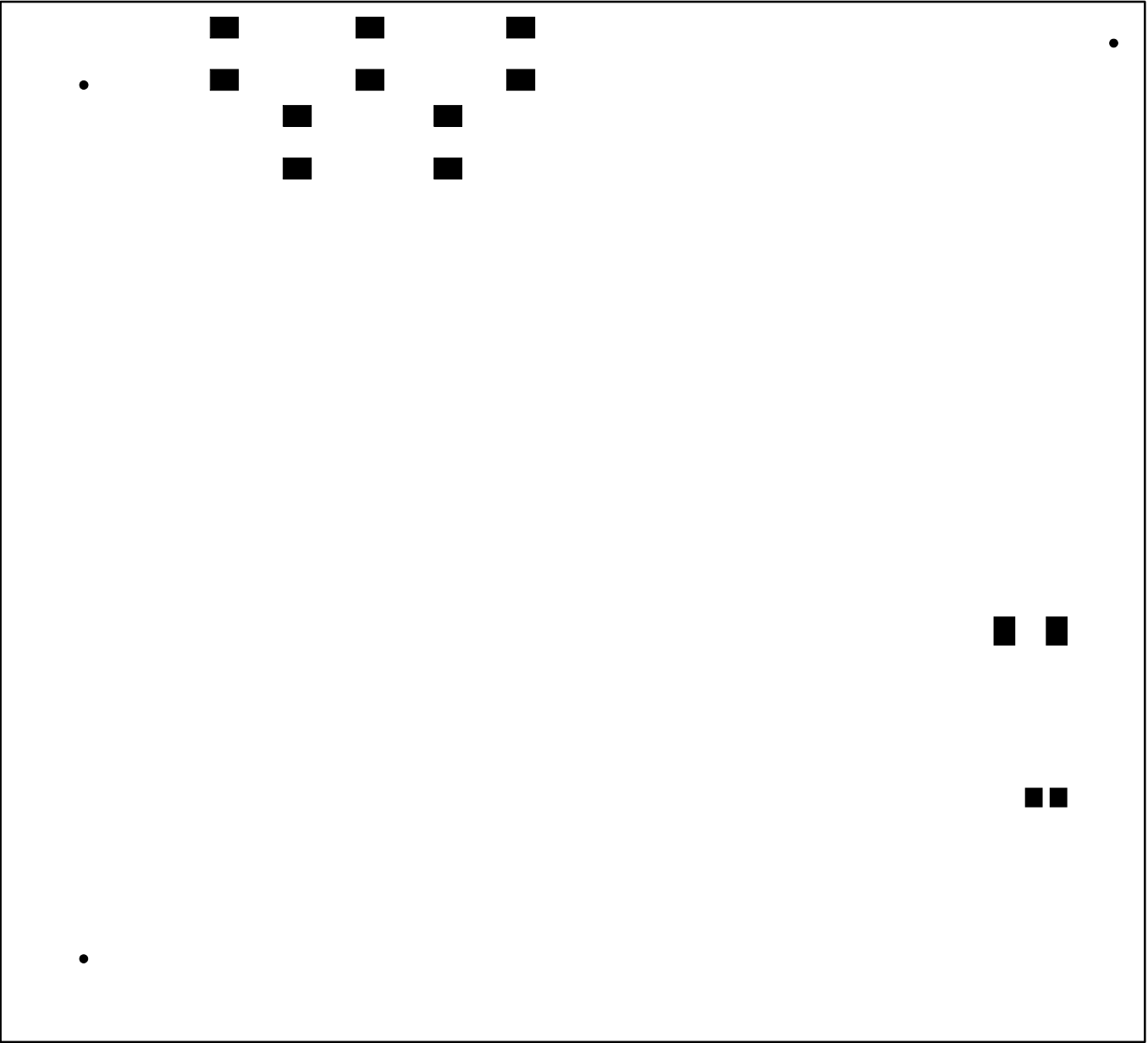


**NOTES:**

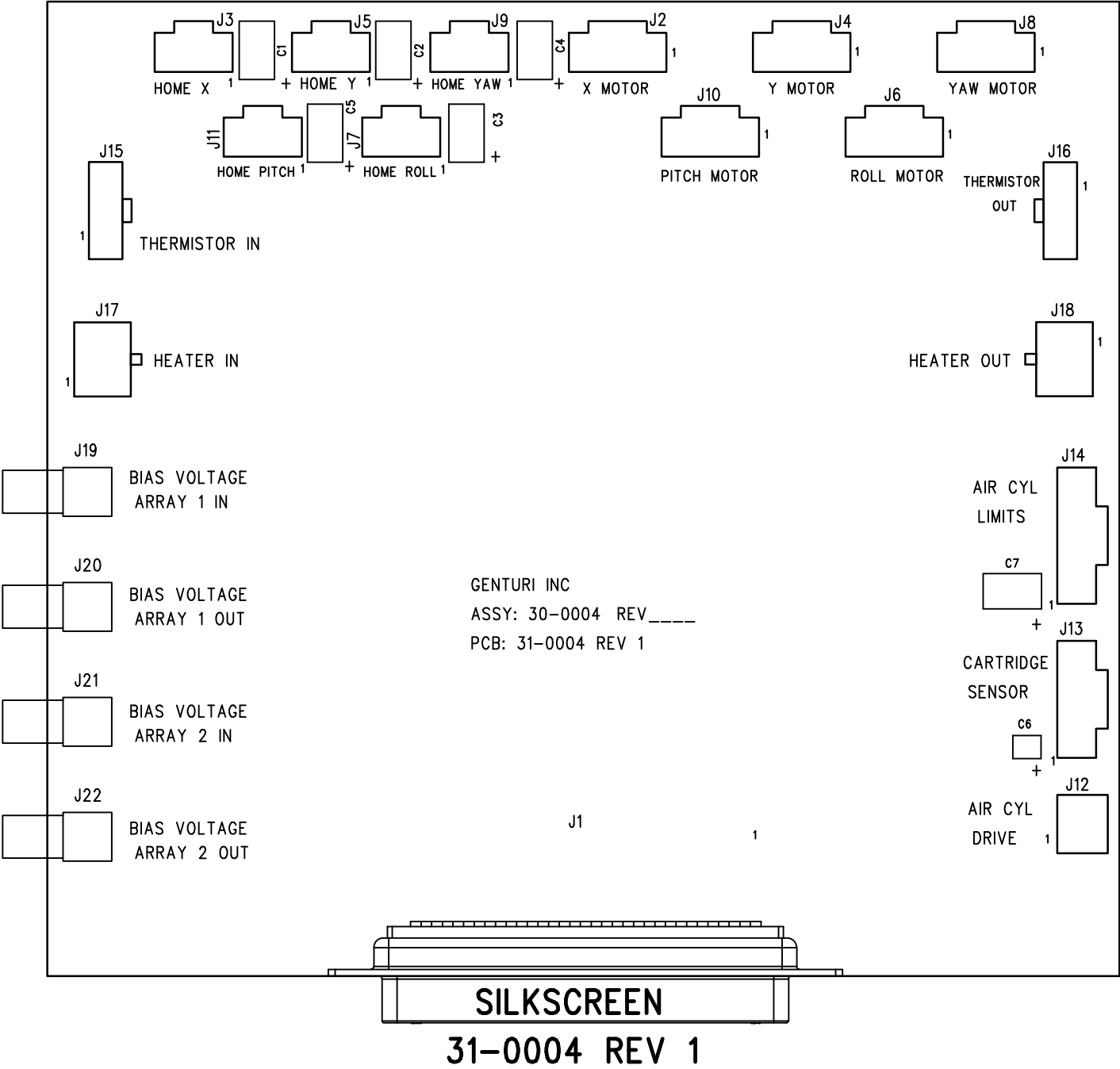
1. MAT'L: 0.062 THK. FR4 COPPERCLAD LAMINATE.
2. ALL HOLES TO BE PLATED THRU WITH A MINIMUM WALL THICKNESS OF 0.001.
3. BOARDS TO BE LPIOBC ON BOTH SIDES - GREEN COLOR.
4. BOARDS TO BE ENIG FINISH AFTER SOLDERMASK.
5. BOARDS TO BE SILKSCREENED ON TOP SIDE WITH PERMANENT, WHITE EPOXY (CHEMICAL AND SCRATCH RESISTANT).
6. BOARDS TO BE ELECTRICALLY TESTED FOR SHORTS AND OPENS.
7. BOARDS SHALL BE MADE FROM UNDERWRITER LABORATORY RECOGNIZED MATERIAL AND THE FINISHED BOARD MUST CARRY THE VENDOR'S U.L. LOGO AND DATE CODE.
8. ALL DRAWINGS AND FILMS VIEWED FROM TOP SIDE.

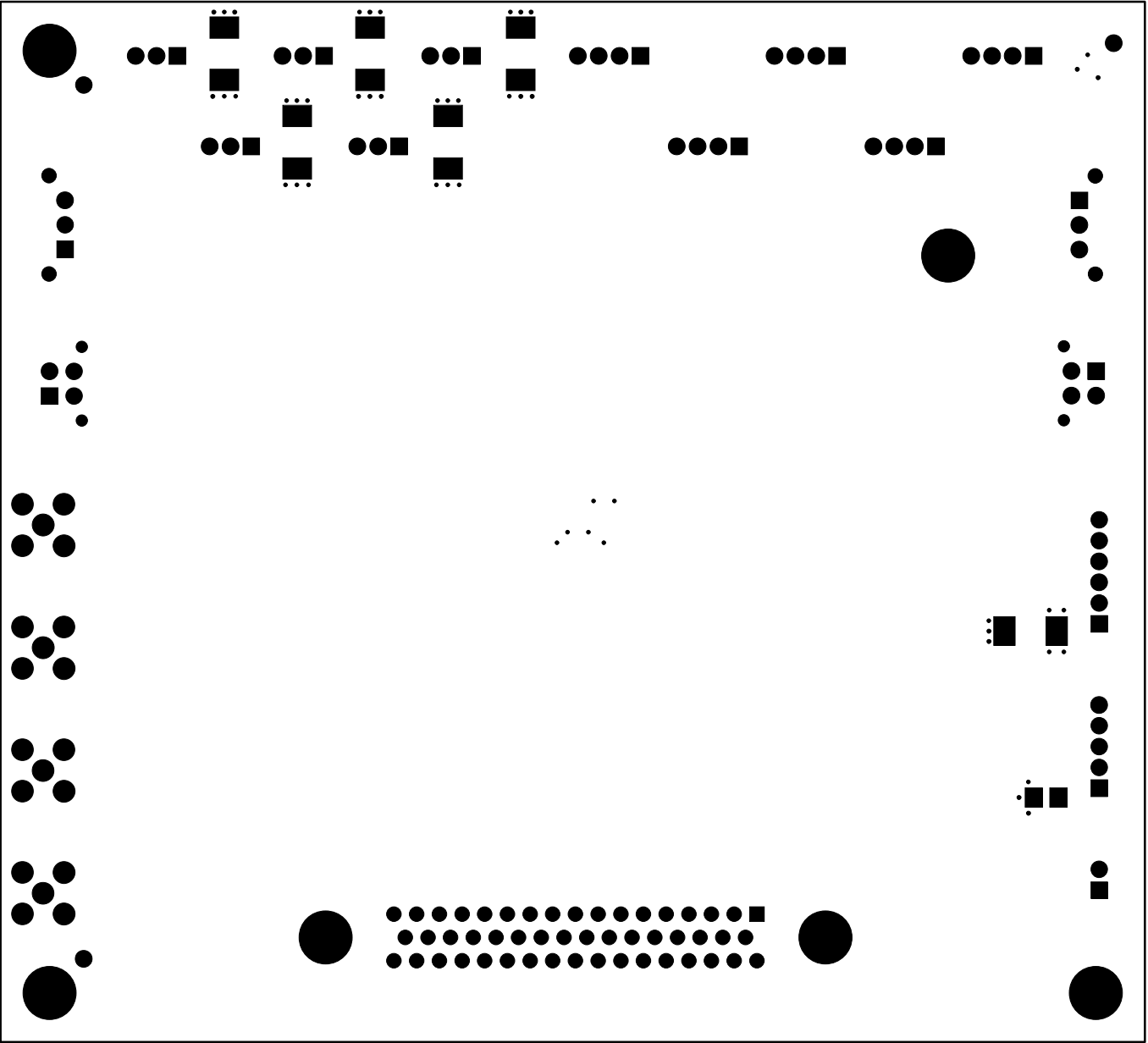
DRILL CHART			
SYMBOL	SIZE	QTY	PLATED TYPE
+	0.010 +0/-0.005	49	PLATED
X	0.040 +/-0.003	4	NON-PLATED
◻	0.043 +/-0.003	112	PLATED
◊	0.050 +/-0.003	4	NON-PLATED
⊗	0.059 +/-0.003	4	PLATED
⊠	0.063 +/-0.003	16	PLATED
A	0.126 +/-0.003	2	PLATED
B	0.157 +/-0.003	4	PLATED



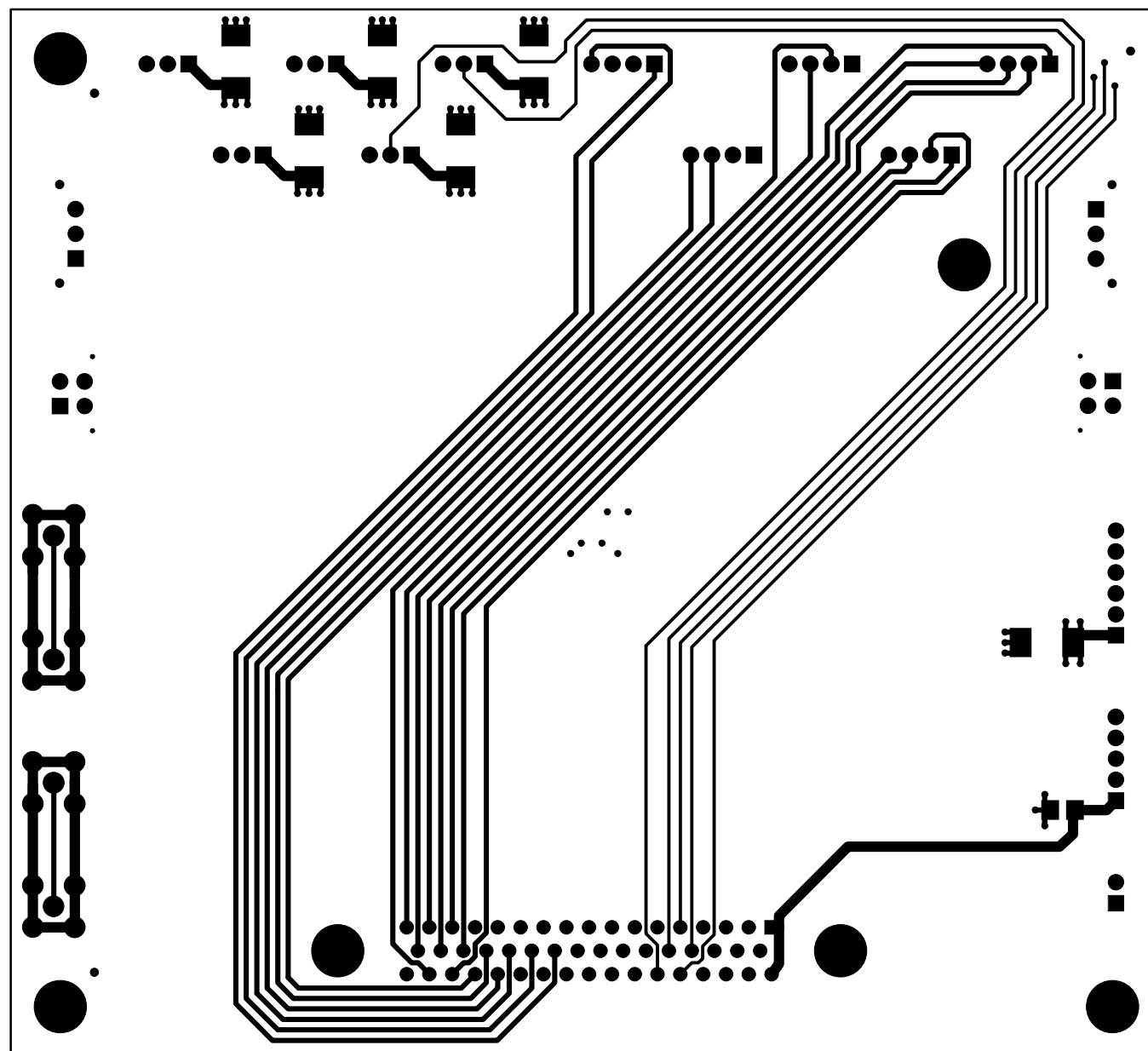


SOLDERPASTE  
31-0004 REV 1

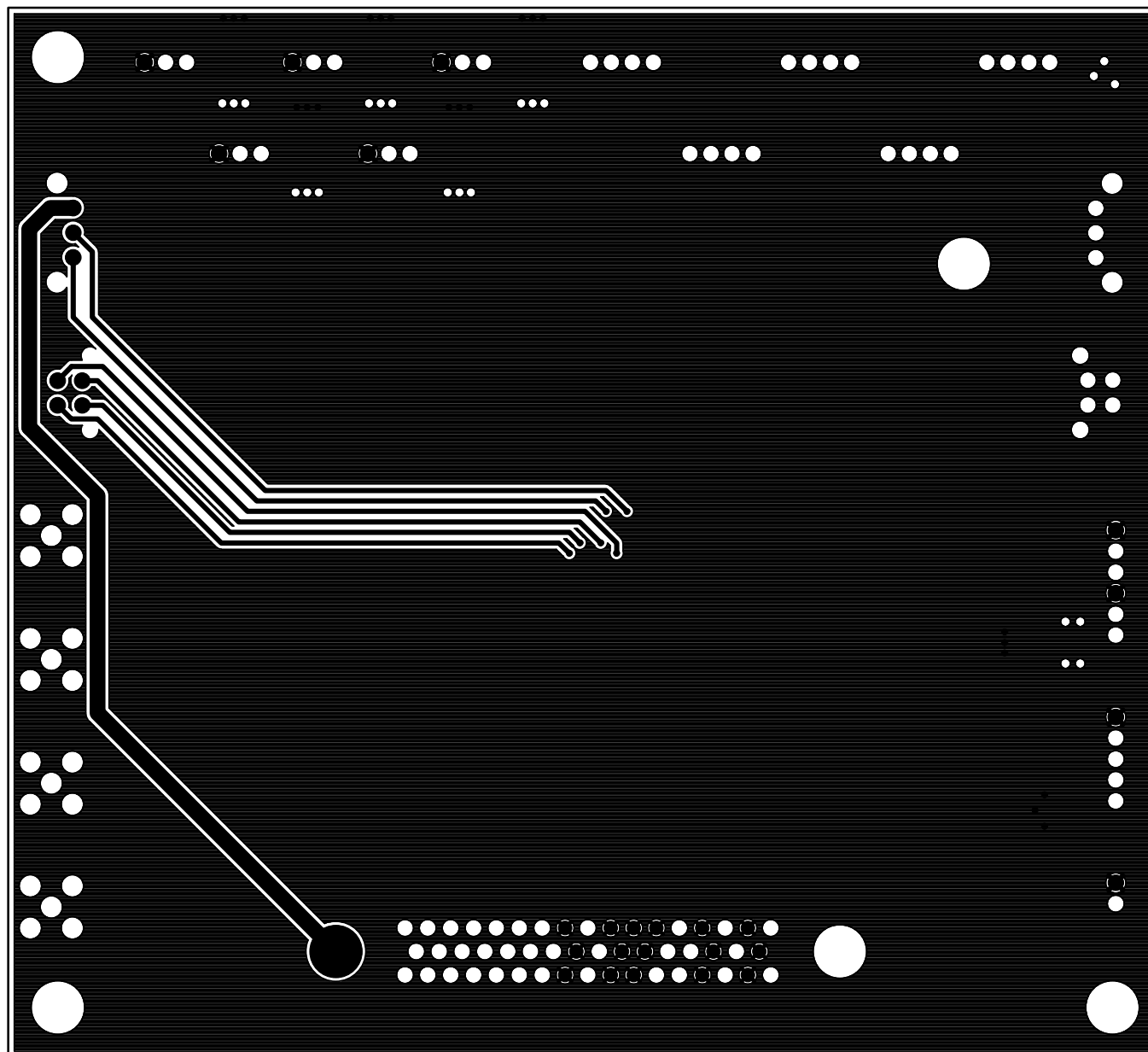




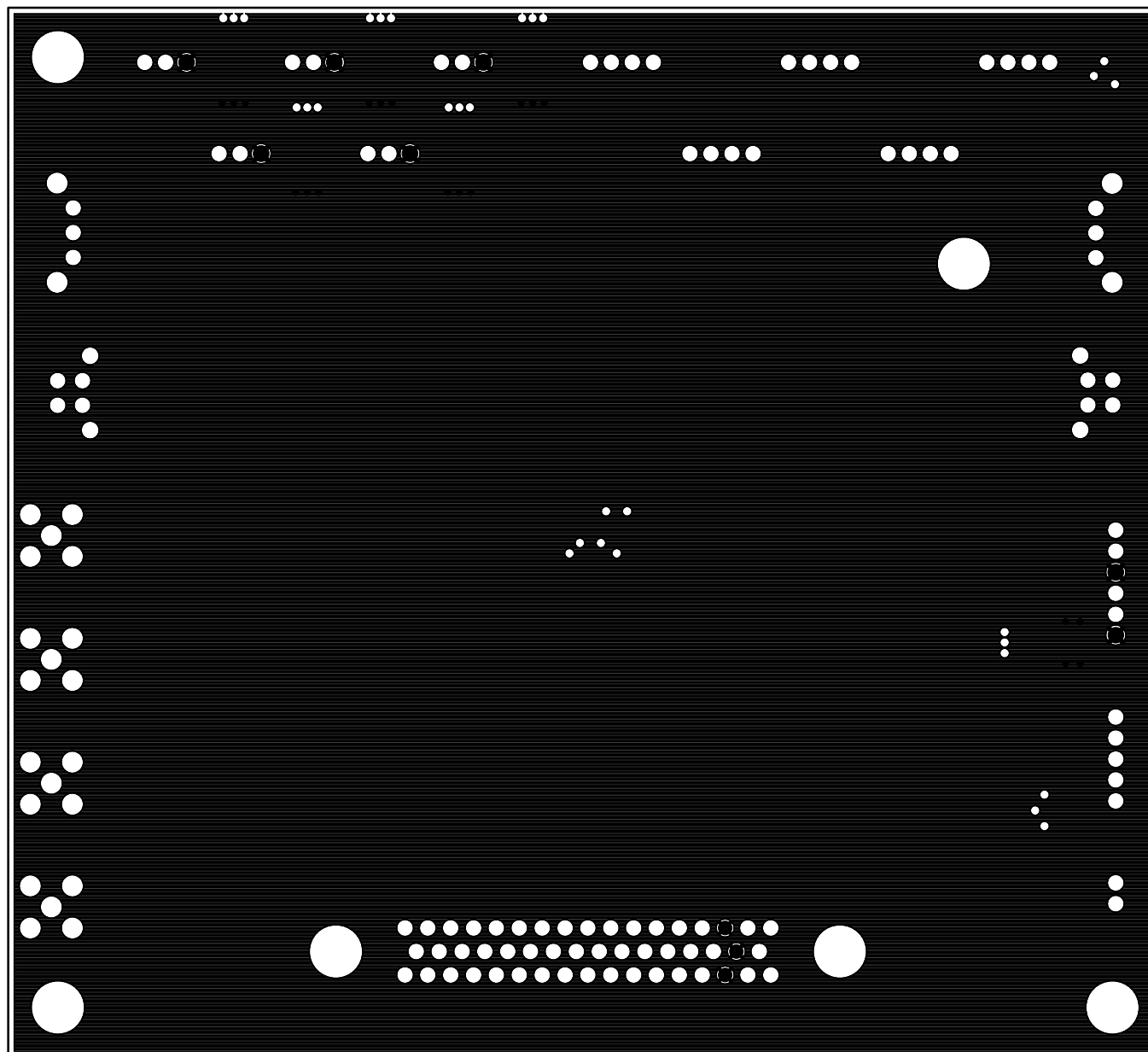
SOLDERMASK TOP SIDE  
31-0004 REV 1



TOP SIDE  
31-0004 REV 1

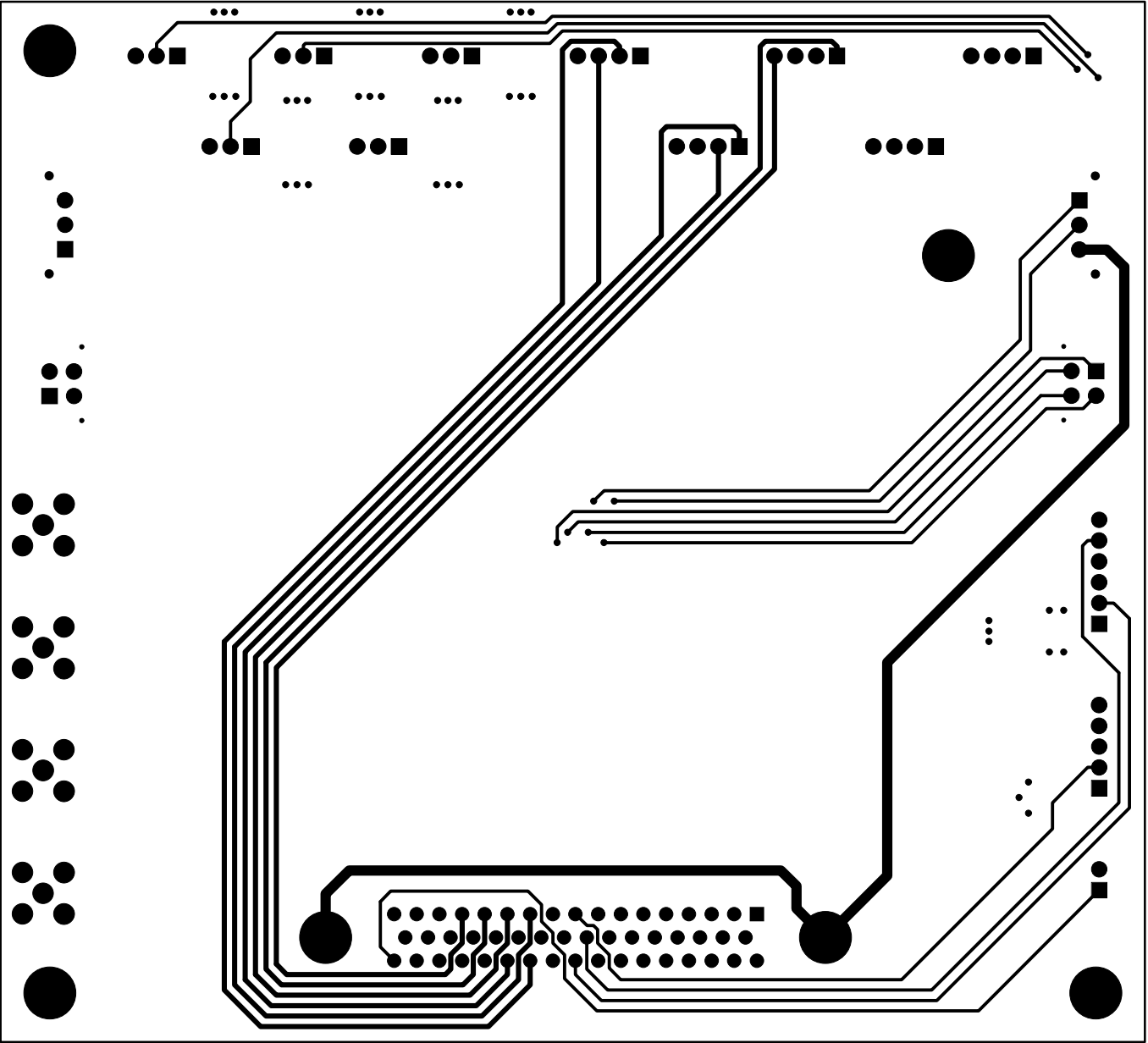


LAYER 2 GROUND  
31-0004 REV 1

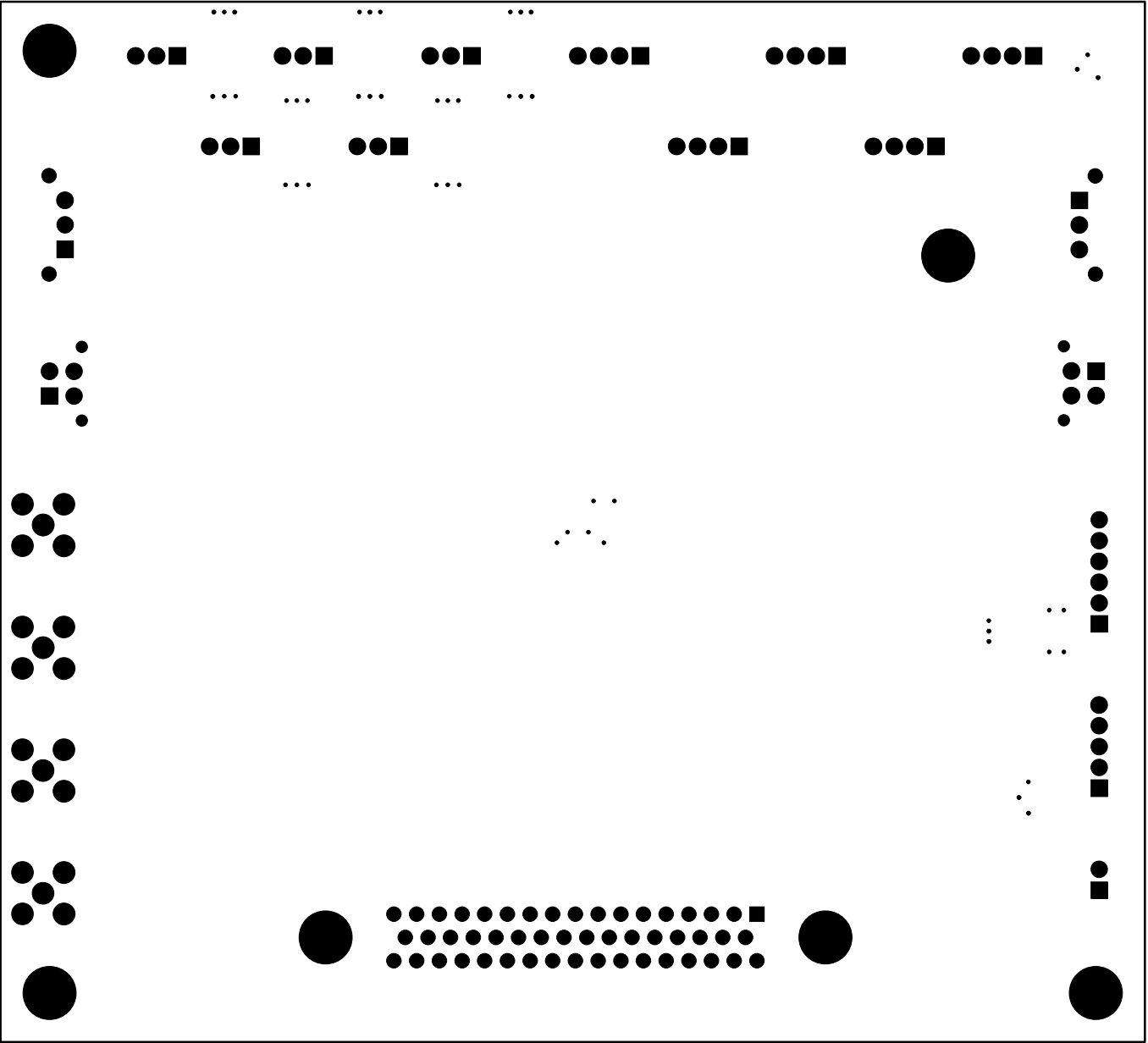


LAYER 3 POWER  
31-0004 REV 1





31-0004 REV 1  
BOTTOM SIDE



31-0004 REV 1  
SOLDERMASK BOTTOM SIDE